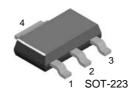


January 2007

# **NZT605 NPN Darlington Transistor**

- · This device designed for applications requiring extremely high gain at collector currents to 1.0A and high breakdown voltage.
- · Sourced from process 06.



1. Base 2.4. Collector 3. Emitter

# Absolute Maximum Ratings \* T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CEO</sub>	Collector-Emitter Voltage	110	V
V <sub>CBO</sub>	Collector-Base Voltage	140	V
$V_{EBO}$	Emitter-Base Voltage	10	V
I <sub>C</sub>	Collector Current - Continuous	1.5	A
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

# **Electrical Characteristics \*** $T_C = 25$ °C unless otherwise noted

Parameter	Conditions	Min.	Max	Units			
Off Characteristics							
Collector-Emitter Breakdown Voltage *	I <sub>C</sub> = 10mA, I <sub>B</sub> = 0	110		V			
Collector-Base Breakdown Voltage	$I_C = 100 \mu A, I_E = 0$	140		V			
Emitter-Base Breakdown Voltage	$I_E = 100 \mu A, I_C = 0$	10		V			
Collector Cutoff Current	V <sub>CB</sub> = 120V, I <sub>E</sub> = 0		10	nA			
Collector Cutoff Current	V <sub>CE</sub> = 120V, I <sub>E</sub> = 0		10	nA			
Emitter Cut-off Current	$V_{EB} = 8.0V, I_{C} = 0$		100	nA			
ristics *							
DC Current Gain	$V_{CE} = 5.0V$ , $I_{C} = 50mA$ $V_{CE} = 5.0V$ , $I_{C} = 500mA$ $V_{CE} = 5.0V$ , $I_{C} = 1.0A$ $V_{CE} = 5.0V$ , $I_{C} = 1.5A$ $V_{CE} = 5.0V$ , $I_{C} = 2.0A$	2000 5000 2000 300 200	100K				
Collector-Emitter Saturation Voltage	I <sub>C</sub> = 250mA, I <sub>B</sub> = 0.25mA I <sub>C</sub> = 1.0A, I <sub>B</sub> = 1.0mA		1 1.5	V			
Base-Emitter Saturation Voltage	I <sub>C</sub> = 1.0A, I <sub>B</sub> = 1.0mA		1.8	V			
Base-Emitter On Voltage	I <sub>C</sub> = 1.0A, V <sub>CE</sub> = 5.0V		1.7	V			
characteristics				•			
Transition Frequency	I <sub>C</sub> = 100mA, V <sub>CE</sub> = 10V, f = 20MHz	150		MHz			
	Collector-Emitter Breakdown Voltage * Collector-Base Breakdown Voltage Emitter-Base Breakdown Voltage Collector Cutoff Current Collector Cutoff Current Emitter Cut-off Current  Tristics *  DC Current Gain  Collector-Emitter Saturation Voltage Base-Emitter On Voltage Characteristics	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			

<sup>\*</sup> Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2.0%

<sup>1.</sup> These ratings are based on a maximum junction temperature of 150 degrees C.

2. These are steady limits. The factory should be consulted on application involving pulsed or low duty cycle operations

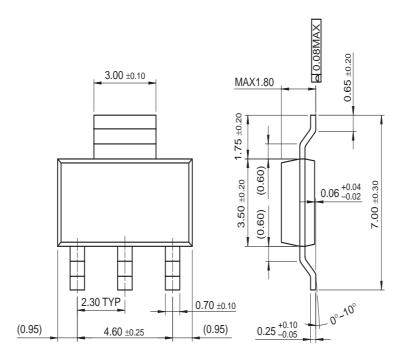
# Thermal Characteristics $T_a = 25$ °C unless otherwise noted

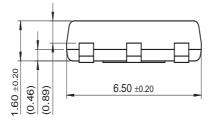
Symbol	Parameter	Max.	Units
$P_{D}$	Total Device Dissipation Derate above 25°C	1,000 8.0	mW mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	125	°C/W

<sup>\*</sup> Device mounted on FR-4PCB 36mm  $\times$  18mm  $\times$  1.5mm; mounting pad for the collector lead min. 6cm<sup>2</sup>

### **Mechanical Dimensions**

# **SOT-223**





Dimensions in Millimeters

UniFET™

 $VCX^{TM}$ 

Wire™



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